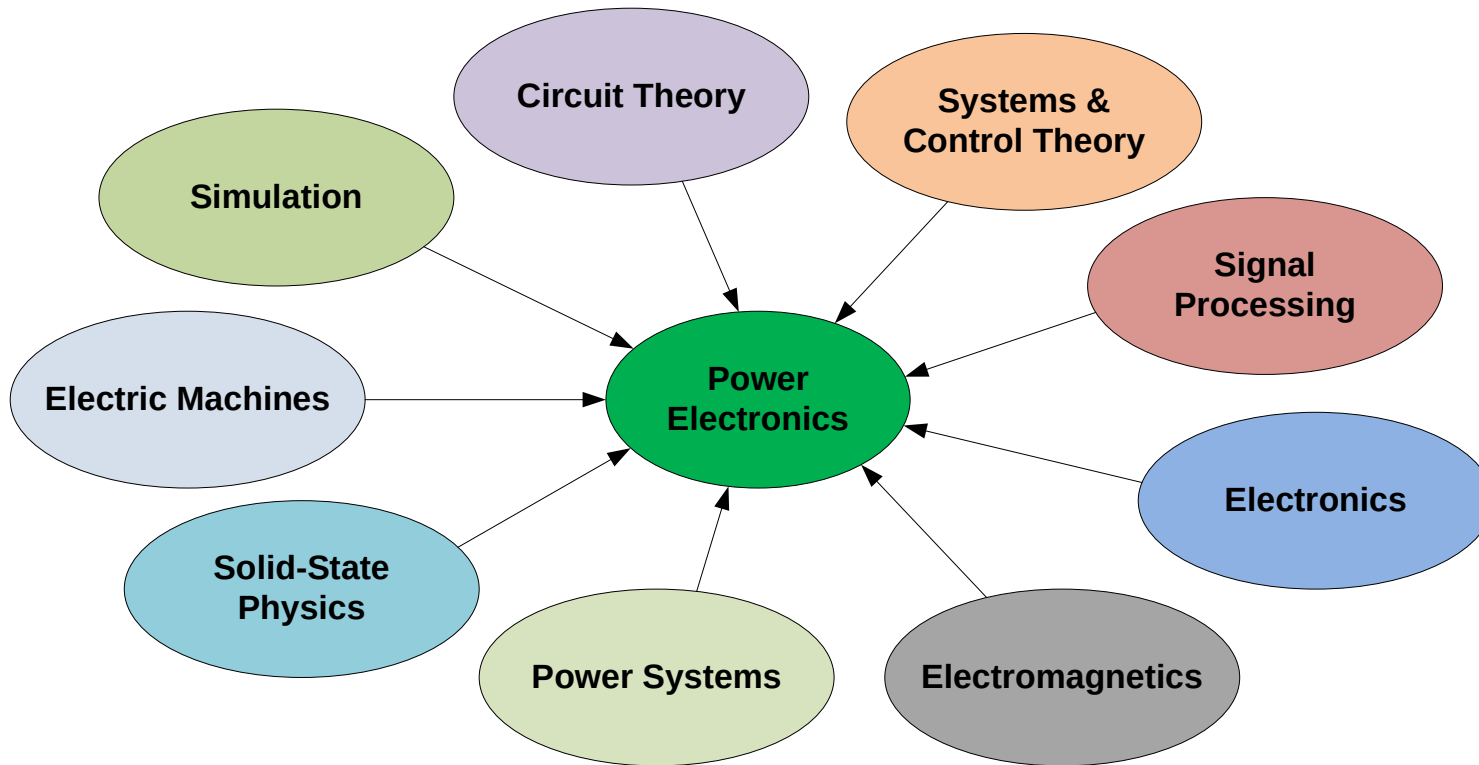




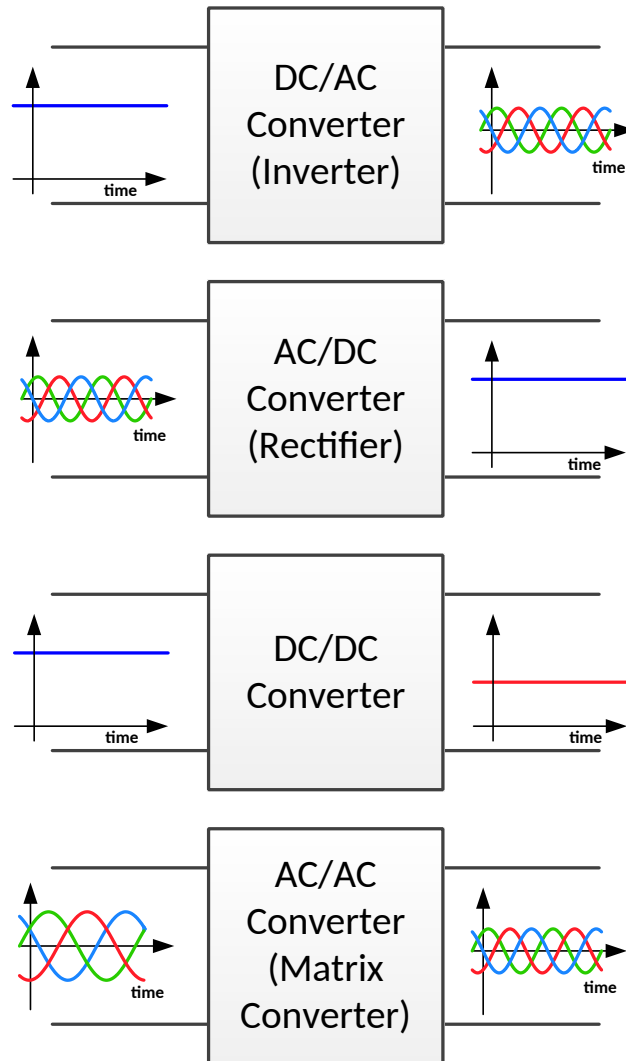
# Power Electronics Overview

## Overview – *Power Electronics*

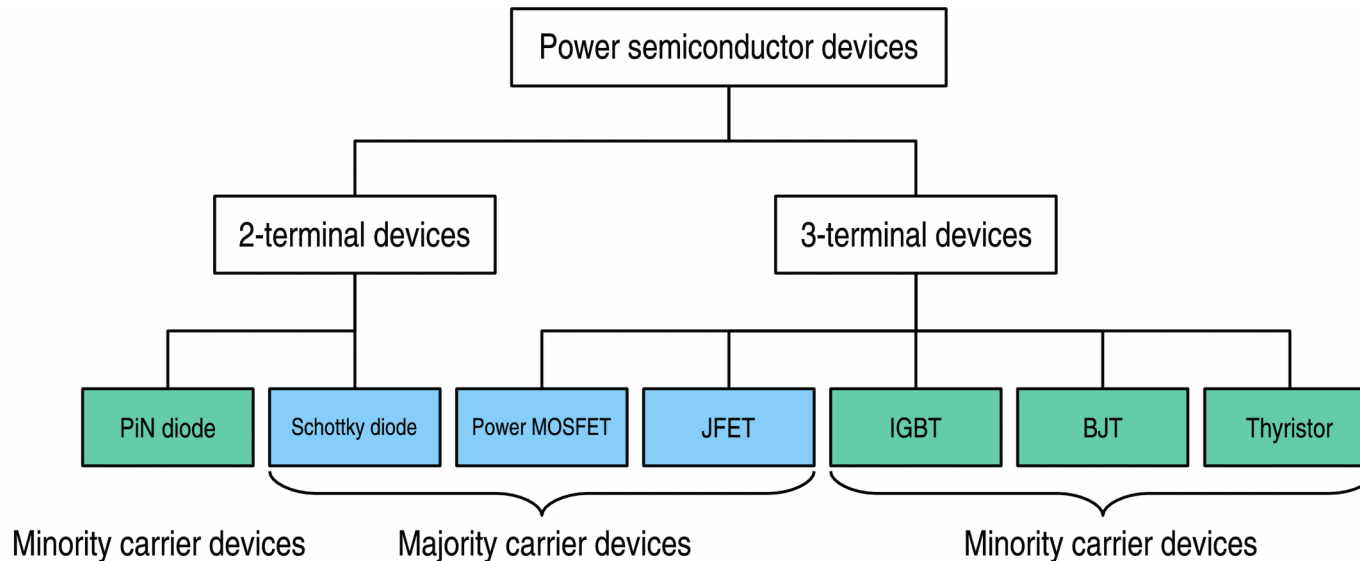


Interdisciplinary Nature of Power Electronics

## Overview – *Converter Topologies*



electrical power  
processing

Semiconductors – *Power Electronics Devices*

Power Electronic Devices (copied from  
[https://commons.wikimedia.org/wiki/File:Power\\_devices\\_family.png](https://commons.wikimedia.org/wiki/File:Power_devices_family.png))

## Semiconductors – *Power Electronics Devices*

Common Semiconductors:

Material	Symbol	Group
Germanium	Ge	IV
Silicon	Si	IV
Gallium Arsenide	GaAs	III-V
Silicon Carbide	SiC	IV
Gallium Nitride	GaN	III-V
Gallium Phosphide	GaP	III-V

Elemental Semiconductors

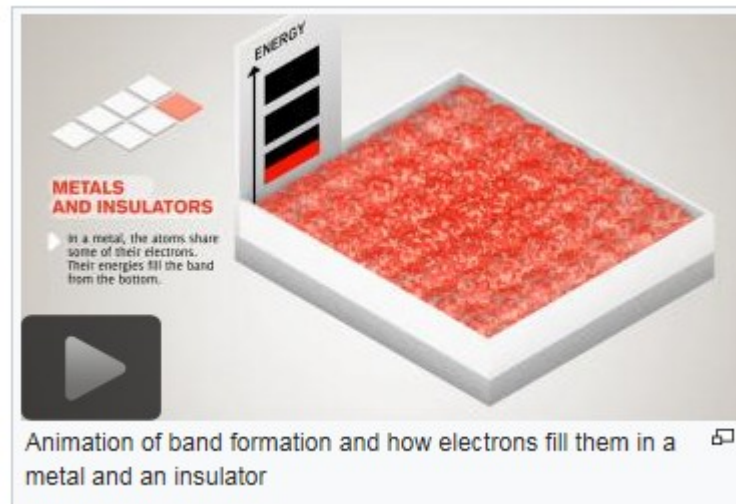
Compound Semiconductors

																1 H 1.008
																2 He 4.003
				5 B 10.811	6 C 12.011	7 N 14.007	8 O 15.999	9 F 18.998	10 Ne 20.180							
				13 Al 26.982	14 Si 28.086	15 P 30.974	16 S 32.06	17 Cl 35.453	18 Ar 39.948							
30 Zn 65.38				31 Ga 69.723	32 Ge 72.64	33 As 74.922	34 Se 78.96	35 Br 79.904	36 Kr 83.8							
48 Cd 112.415	49 In 75.75	50 Sn 118.71	51 Sb 121.76	52 Te 127.6	53 I 126.905	54 Xe 131.29										
80 Hg 200.59	81 Tl 204.38	82 Pb 207.2	83 Bi 208.98	84 Po [209]	85 At [210]	86 Rn [222]										
112 Cn [285]	113 Nh [286]	114 Fl [289]	115 Mc [290]	116 Lv [293]	117 Ts [294]	118 Og [294]										

## Semiconductors – *Power Electronics Devices*

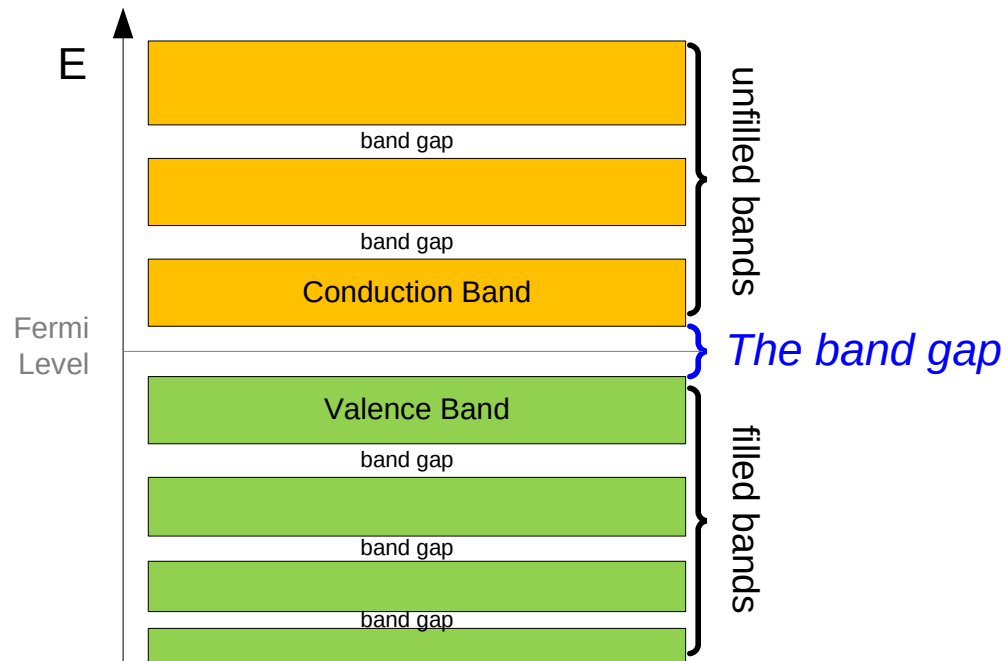
The Fermi-Dirac distribution function gives the probability that (at thermodynamic equilibrium) a state having energy  $\epsilon$  is occupied by an electron:

at Fermi Level

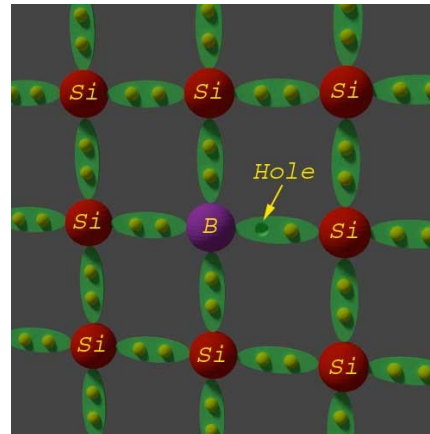
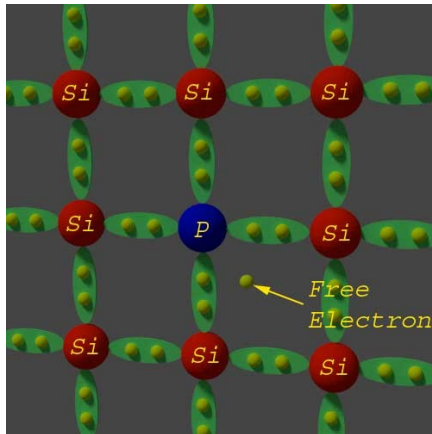


Copied from ([https://en.wikipedia.org/wiki/Electronic\\_band\\_structure](https://en.wikipedia.org/wiki/Electronic_band_structure))

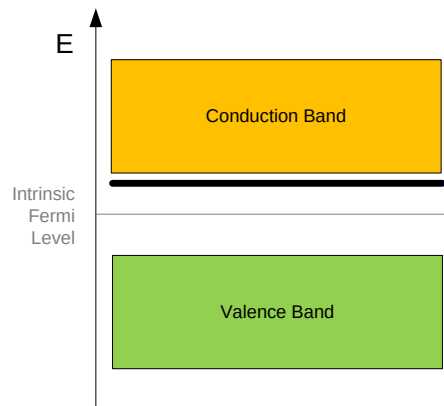
## Semiconductors – *Power Electronics Devices*



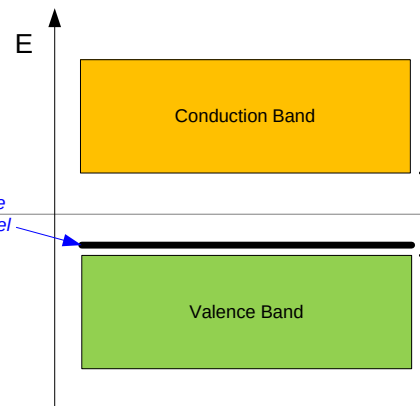
## Semiconductors – *Power Electronics Devices*



pictures from  
<http://www.electrical4u.com/donor-and-acceptor-impurities-in-semiconductor/>



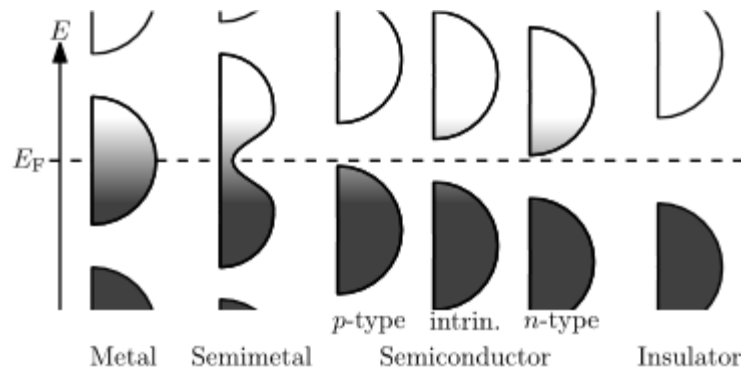
n-Type Material



p-Type Material

The band gap  
(forbidden zone)



Semiconductors – *Power Electronics Devices*

Filling of the electronic states in various types of materials at equilibrium. Here, height is energy while width is the density of available states for a certain energy in the material listed. The shade follows the Fermi–Dirac distribution (black = all states filled, white = no state filled). In metals and semimetals the Fermi level  $E_F$  lies inside at least one band. In insulators and semiconductors the Fermi level is inside a band gap; however, in semiconductors the bands are near enough to the Fermi level to be thermally populated with electrons or holes. (Copied from [https://en.wikipedia.org/wiki/Fermi\\_level](https://en.wikipedia.org/wiki/Fermi_level))

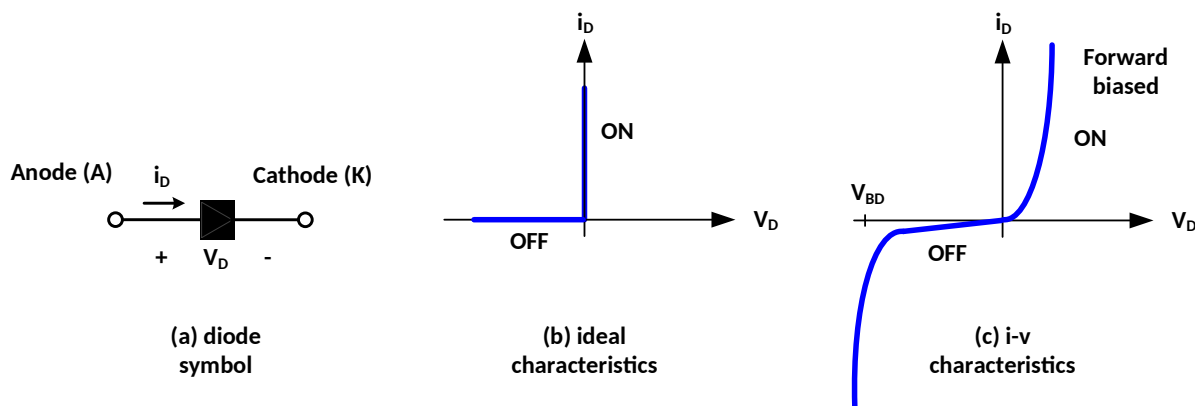
## Semiconductors – *Power Diodes*

### Power Diode

- First power diode developed in 1952
- Replaced mercury-arc converters



### Diode

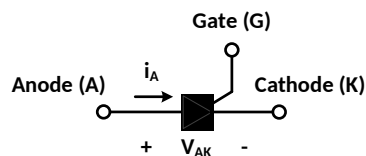
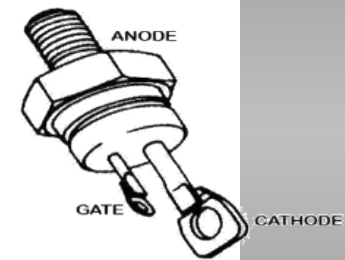


Diode Characteristics

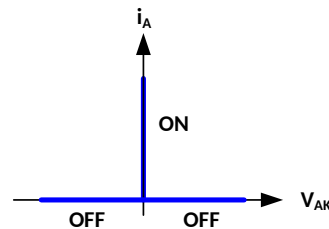
## Semiconductors – *Silicon Controlled Rectifier*

### Thyristor – Silicon Controlled Rectifier (SCR)

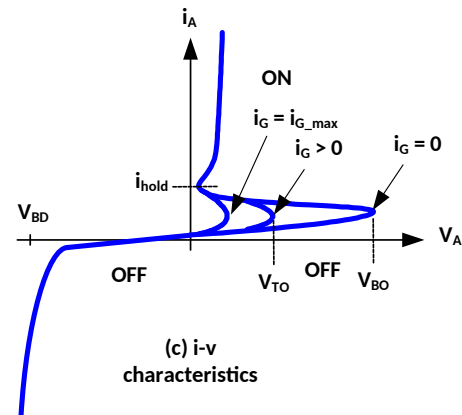
- First commercially available power electronic device (GE – 1957)
- Was essentially the only viable power electronics device for the next 25 years
- Converts AC grid power to DC
  - DC machines (process industry, traction drives, etc.)
  - DC power supplies (welding, metal plating, battery chargers, etc.)
- Load Commutated Device (turns off when current goes to zero)
- Later developments in SCRs □ GTO, MCT, IGCT (Turn-off devices)



(a) SCR symbol



(b) ideal characteristics



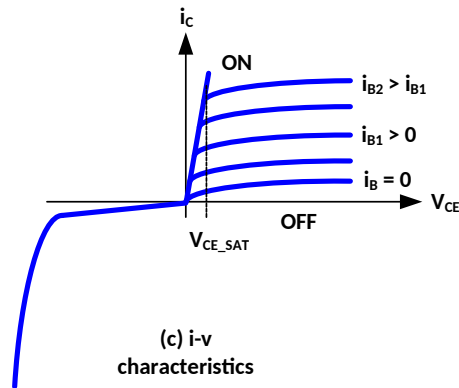
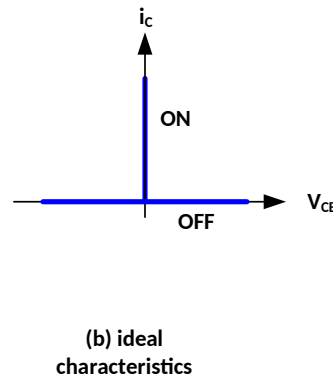
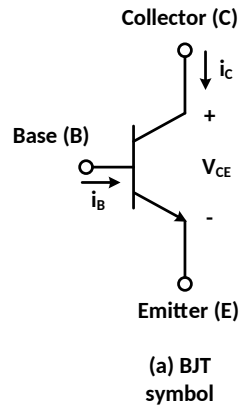
(c) i-v characteristics

### Thyristor Characteristics

## Semiconductors – *Power BJT*

### Bipolar Junction Transistor

- Developed in 1970
- Low to medium power and frequency
- Difficult base drive requirements (current controlled)
- Essentially obsolete due to voltage controlled (FET) devices

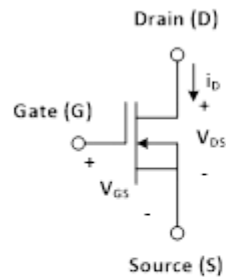


BJT Characteristics

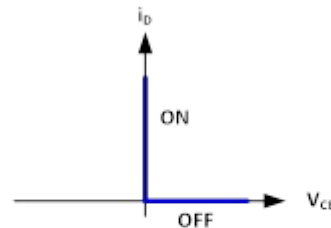
## Semiconductors – *Power MOSFET*

### MOSFET

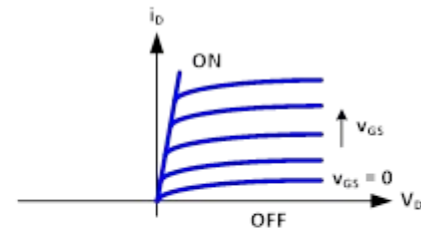
- Developed in 1978
  - Voltage controlled gate □ low gate drive power required
  - Used pervasively in low to medium power
- Capable of very high frequency



(a) MOSFET symbol



(b) ideal characteristics



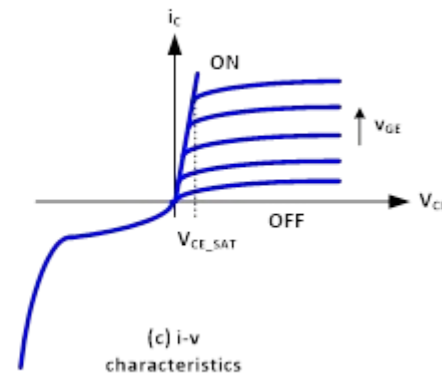
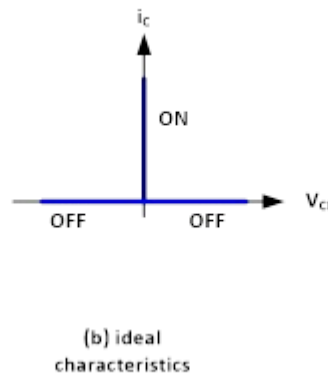
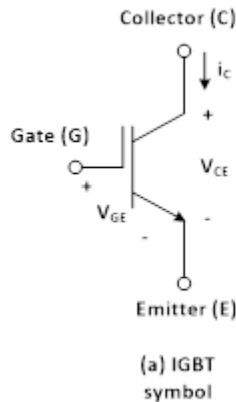
(c) i-v characteristics

MOSFET Characteristics

## Semiconductors – *Insulated Gate Bipolar Transistor*

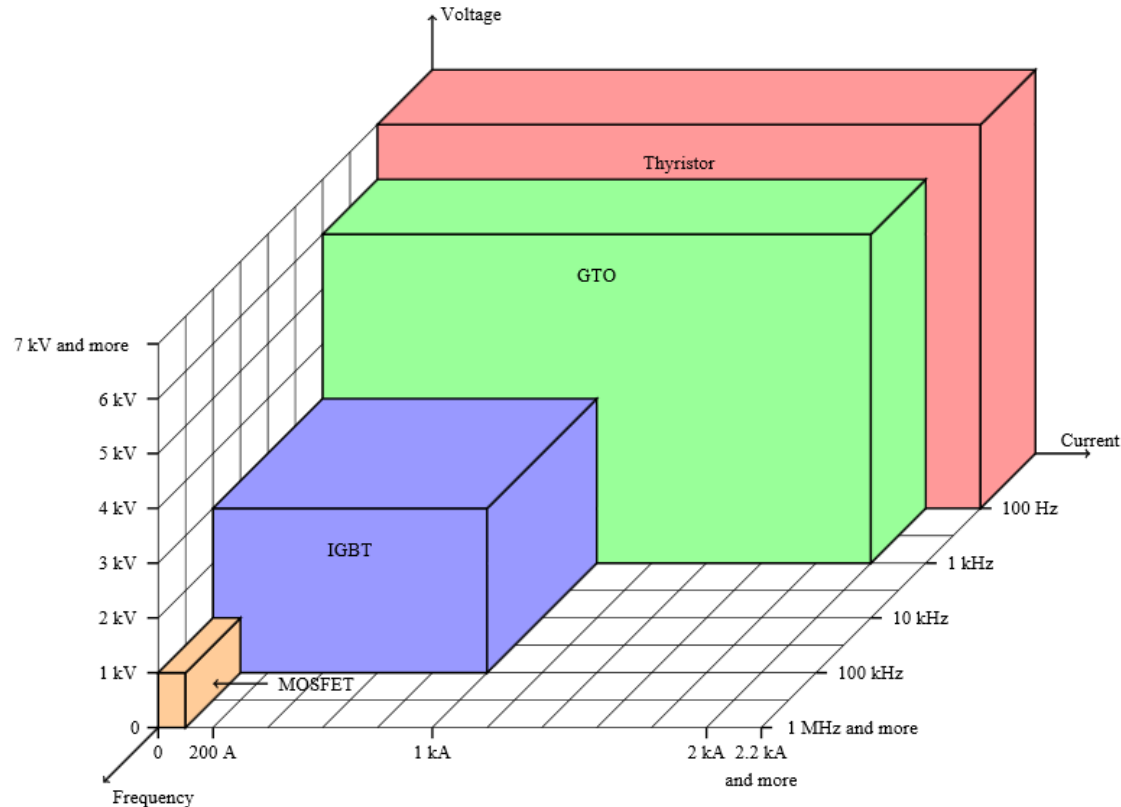
### IGBT

- Developed in 1983
  - Combined power of BJT and gate control of MOSFET
- Currently on 6<sup>th</sup> generation design



IGBT Characteristics

## Semiconductors – *Power Range*



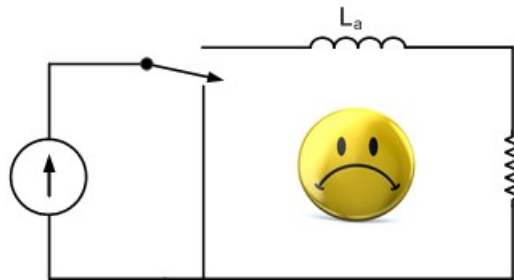
Current/Voltage/Switching Frequency Domains of Main Power Electronic Switches  
(Copied from [https://en.wikipedia.org/wiki/Power\\_semiconductor\\_device](https://en.wikipedia.org/wiki/Power_semiconductor_device))

## Semiconductors – *Golden Rules of Power Electronics*

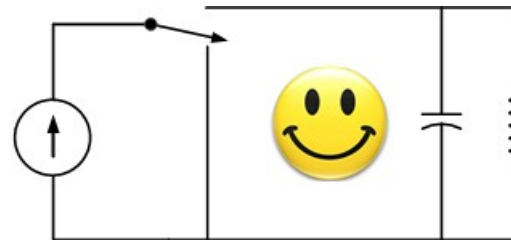
### Power Electronics Review

#### Basic Rules of Power Electronics

- Inductor current cannot change instantaneously
- Capacitor voltage cannot change instantaneously
- Average voltage across an inductor = 0
- Average current through a capacitor = 0
- Energy is always conserved



Not good, cannot change current instantaneously through an inductor



No problem, capacitor current can change instantaneously, voltage cannot